

L Number	Hits	Search Text	DB	Time stamp
1	12	(contact adj hole or open\$3) same (silicon near node)	USPAT; US-PGPUB	2002/12/17 09:42
2	5	((contact adj hole or open\$3) same (silicon near node) ) and @pd<19990722	USPAT; US-PGPUB	2002/12/17 09:39
3	61099	(contact adj hole or open\$3) same silicon	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/17 09:51
4	3098	((contact adj hole or open\$3) same silicon ) same (mask\$3 near5 photoresist)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/17 09:56
5	2603	((((contact adj hole or open\$3) same silicon ) same (mask\$3 near5 photoresist)) same etch\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/17 09:58
6	136	(((((contact adj hole or open\$3) same silicon ) same (mask\$3 near5 photoresist)) same etch\$3) and ((remov\$3 or clean\$3 or etch\$3) same (etch\$3 near5 residue))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/17 10:00
7	41	(((((contact adj hole or open\$3) same silicon ) same (mask\$3 near5 photoresist)) same etch\$3) and ((remov\$3 or clean\$3 or etch\$3) same (etch\$3 near5 residue))) and @pd<19990722	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/17 10:08
8	1	(((((contact adj hole or open\$3) same silicon ) same (mask\$3 near5 photoresist)) same etch\$3) and ((remov\$3 or clean\$3 or etch\$3) same (etch\$3 near5 residue))) and @pd<19990722) and (temperature near5 ("400" near degree))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/12/17 10:09
-	1	("5576071").PN.	USPAT; US-PGPUB	2002/06/25 13:18
-	0	("(contact adj hole or open\$3) same silicon").PN.	USPAT; US-PGPUB	2002/06/25 13:30
-	37955	(contact adj hole or open\$3) same silicon	USPAT; US-PGPUB	2002/06/25 13:34
-	10	(contact adj hole or open\$3) same (silicon near node)	USPAT; US-PGPUB	2002/12/17 09:37
-	1	("6159852").PN.	USPAT; US-PGPUB	2002/06/25 13:50
-	1	("5661115").PN.	USPAT; US-PGPUB	2002/06/25 13:50